TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

## TC74VHC273F, TC74VHC273FT, TC74VHC273FK

#### Octal D-Type Flip-Flop with Clear

The TC74VHC273 is an advanced high speed CMOS OCTAL D-TYPE FLIP FLOP fabricated with silicon gate  $\rm C^2MOS$  technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

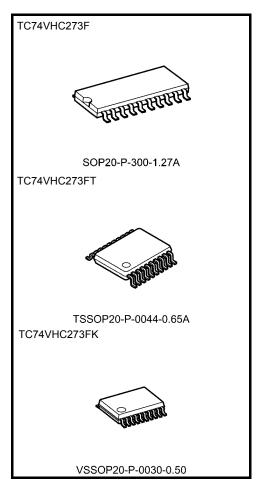
Information signals applied to D inputs are transferred to the Q outputs on the positive going edge of the clock pulse.

When the  $\overline{\text{CLR}}$  input is held "L", the Q outputs are at a low logic level independent of the other inputs.

An input protection circuit ensures that 0 to 5.5~V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5~V to 3~V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Features**

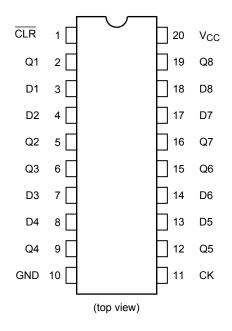
- High speed:  $f_{max} = 165 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range:  $V_{CC \text{ (opr)}} = 2 \text{ to } 5.5 \text{ V}$
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with 74ALS273



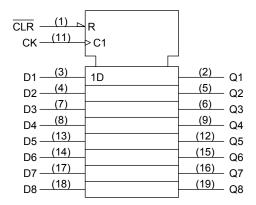
Weight

SOP20-P-300-1.27A : 0.22 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

#### **Pin Assignment**



## **IEC Logic Symbol**

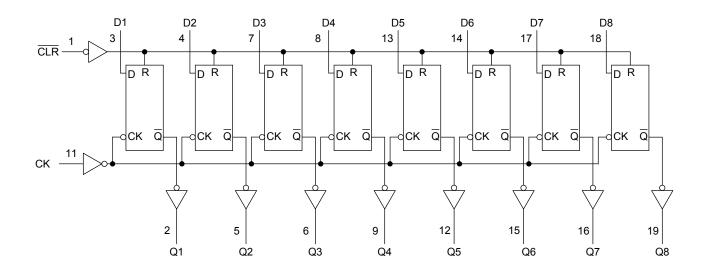


#### **Truth Table**

	Inputs		Output	Function		
CLR	D	CK	Q	Function		
L	Х	Х	L	Clear		
Н	L		L	_		
Н	Н		Н	_		
Н	Х	$\neg$	$Q_n$	No Change		

X: Don't care

## **System Diagram**





#### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	−0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	l <sub>IK</sub>	-20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±75	mA
Power dissipation	P <sub>D</sub>	180	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	<b>V</b>	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	<b>V</b>	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 100 (V <sub>CC</sub> = $3.3 \pm 0.3$ V)	ns/V	
input rise and fall time	uvuv	0 to 20 (V <sub>CC</sub> = 5 $\pm$ 0.5 V)	IIS/V	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.



#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition V <sub>CC</sub> (V)		Ta = 25°C			Ta = -40 to 85°C		Unit	
	,			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
High lovel input				2.0	1.50	_	_	1.50	_	
voltage	High-level input VIH —		_	3.0 to 5.5	V <sub>CC</sub> × 0.7	_	_	V <sub>CC</sub> × 0.7	_	V
Low-level input				2.0		_	0.50	_	0.50	
voltage	V <sub>IL</sub>	_	_		_	_	V <sub>CC</sub> × 0.3	_	V <sub>CC</sub> × 0.3	V
	Vон	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	1.9	2.0	_	1.9	_	
			I <sub>OH</sub> = -50 μA	3.0	2.9	3.0	_	2.9	_	٧
High-level output voltage				4.5	4.4	4.5	_	4.4		
			$I_{OH} = -4 \text{ mA}$	3.0	2.58		_	2.48		
			$I_{OH} = -8 \text{ mA}$	4.5	3.94	_	_	3.80	_	
	V <sub>OL</sub>			2.0	_	0.0	0.1	_	0.1	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OL} = 50 \mu A$	3.0	_	0.0	0.1	_	0.1	
Low-level output voltage				4.5	_	0.0	0.1	_	0.1	V
			I <sub>OL</sub> = 4 mA	3.0	_	_	0.36	_	0.44	
			$I_{OL} = 8 \text{ mA}$	4.5	_		0.36	_	0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5			±0.1		±1.0	μА
Quiescent supply current	Icc	$V_{IN} = V_{CC}$ or	V <sub>IN</sub> = V <sub>CC</sub> or GND		_	_	4.0	_	40.0	μА

# Timing Requirements (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40 to 85°C	Unit
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width (CK)	t <sub>w (L)</sub>		$3.3\pm0.3$	_	5.5	6.5	ns
Willimum paise width (CK)	t <sub>w (H)</sub>	_	$5.0\pm0.5$	_	5.0	5.0	
Minimum pulse width (CLD)	t <sub>w (L)</sub>	_	$3.3\pm0.3$	_	5.0	6.0	ns
Minimum pulse width ( CLR )			$5.0\pm0.5$	_	5.0	5.0	
Minimum act un tima	ts		$3.3\pm0.3$	_	5.5	6.5	20
Minimum set-up time			$5.0\pm0.5$	_	4.5	4.5	ns
Minimum hold time	t <sub>h</sub>	_	$3.3\pm0.3$	_	1.0	1.0	20
Minimum hold time			$5.0 \pm 0.5$	_	1.0	1.0	ns
Minimum removal time (CLD)	t <sub>rem</sub>	_	$3.3 \pm 0.3$	_	2.5	2.5	20
Minimum removal time ( CLR )			$5.0 \pm 0.5$	_	2.0	2.0	ns



#### AC Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
	,		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	
			3.3 ± 0.3	15	_	8.7	13.6	1.0	16.0	ns
Propagation delay time	$t_{pLH}$			50	_	11.2	17.1	1.0	19.5	
(CK-Q)	$t_{pHL}$	_	5.0 ± 0.5	15	_	5.8	9.0	1.0	10.5	115
			5.0 ± 0.5	50	_	7.3	11.0	1.0	12.5	
			3.3 ± 0.3	15	_	8.9	13.6	1.0	16.0	ns ns
Propagation delay time	t <sub>pHL</sub>	_		50	_	11.4	17.1	1.0	19.5	
(CLR -Q)			5.0 ± 0.5	15	_	5.2	8.5	1.0	10.0	
				50	_	6.7	10.5	1.0	12.0	
	f <sub>max</sub>	_	3.3 ± 0.3	15	75	120	_	65	_	- MHz
Maximum clock				50	50	75	_	45	_	
frequency			5.0 ± 0.5	15	120	165	_	100	_	
				50	80	110	_	70	_	
Output to output akow	t <sub>osLH</sub>	(Note 1)	$3.3 \pm 0.3$	50	_	_	1.5	_	1.5	- ns
Output to output skew	t <sub>osHL</sub>	(Note 1)	5.0 ± 0.5	50	_	_	1.0	_	1.0	
Input capacitance	C <sub>IN</sub>		_		_	4	10	_	10	pF
Power dissipation capacitance	$C_{PD}$			(Note 2)	_	31	_	_	_	pF

Note 1: Parameter guaranteed by design.

 $t_{OSLH} = |t_{pLHm} - t_{pLHn}|, t_{OSHL} = |t_{pHLm} - t_{pHLn}|$ 

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

And the total C<sub>PD</sub> when n pcs.of flip flop operate can be gained by the following equation:

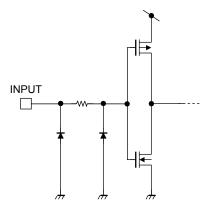
 $C_{PD}$  (total) = 22 + 9·n

### Noise Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Ta =	Unit		
Characteristics	Symbol		V <sub>CC</sub> (V)	Тур.	Max	Oill
Quiet output maximum dynamic $V_{OL}$	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.5	0.8	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.5	-0.8	V
Minimum high level dynamic input voltage	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	_	3.5	V
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	_	1.5	V

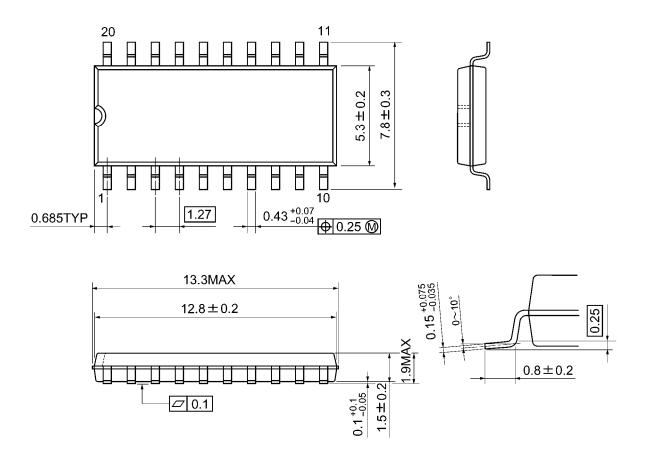


# **Input Equivalent Circuit**



## **Package Dimensions**

SOP20-P-300-1.27A Unit: mm

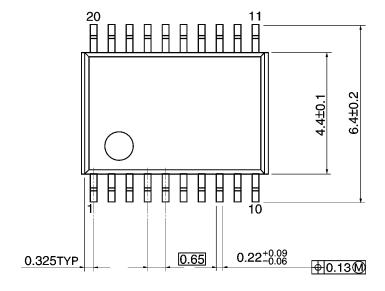


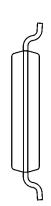
Weight: 0.22 g (typ.)

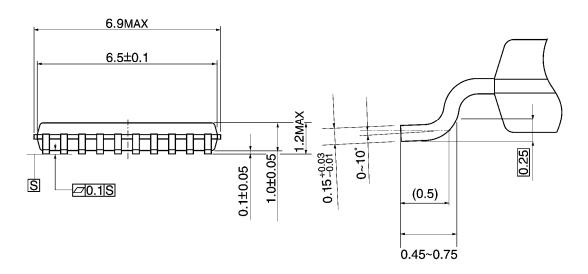
## **Package Dimensions**

TSSOP20-P-0044-0.65A

Unit: mm



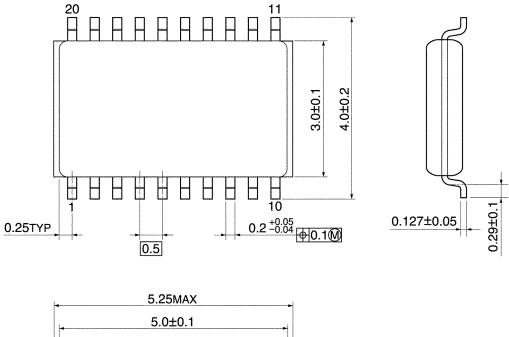


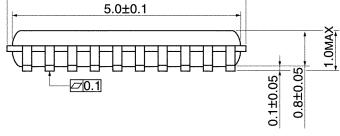


Weight: 0.08 g (typ.)

## **Package Dimensions**

VSSOP20-P-0030-0.50 Unit: mm





Weight: 0.03 g (typ.)

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